

Bachelor of Engineering in Computer Engineering (4 Years, 240 ECTS)

A hardware-to-software engineering program focused on embedded systems, digital design, computer architecture, and edge AI, combining hands-on labs with systems-level thinking.

Program Overview

- **Award:** B.Eng. in Computer Engineering
- **Duration:** 8 Semesters (4 academic years)
- **Total Credits:** 240 ECTS
- **Delivery:** Lectures (L), Tutorials (T), Laboratories (P), Design Studio (S), Internship (I)
- **Workload:** 1 ECTS \approx 25–30 hours
- **Program Pillars:** Digital Logic & FPGA • Computer Architecture • Embedded Systems • Operating Systems • Networks & Security • Electronics & Sensors • Real-Time Systems • Hardware/Software Co-Design • Engineering Design • Safety & Ethics
- **Signature Experiences:** FPGA design labs, embedded verification bootcamp, and a year-long capstone build.

Graduate Learning Outcomes

Graduates will be able to:

- 1 **System Design.** Design computing systems spanning hardware, firmware, and software components.
- 2 **Embedded Development.** Develop reliable embedded applications with real-time constraints and sensor integration.
- 3 **Digital Design.** Implement and verify digital circuits using HDLs and FPGA toolchains.
- 4 **Architecture & OS.** Analyze performance, memory, and concurrency across architectures and operating systems.
- 5 **Networking & Security.** Build networked systems and apply foundational cybersecurity practices.

- 6 **Testing & Debugging.** Use instrumentation and systematic debugging to isolate faults and validate designs.
- 7 **Teamwork & Ethics.** Collaborate in engineering teams and apply ethical, safety, and sustainability considerations.
- 8 **Industry Applications.** Apply computer engineering to robotics, IoT, automotive, medical devices, and edge AI.

Curriculum Structure

Structured across 8 semesters (30 ECTS each). Most courses are 6 ECTS unless otherwise noted.

Year 1

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| Semester 1 (30 ECTS) | <ul style="list-style-type: none">• Programming I (C/C++) - 6 ECTS• Calculus I - 6 ECTS• Engineering Physics I (Mechanics) - 6 ECTS• Digital Systems I (Logic) - 6 ECTS• Engineering Communication - 6 ECTS |
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| Semester 2 (30 ECTS) | <ul style="list-style-type: none">• Programming II (Data Structures) - 6 ECTS• Linear Algebra for Engineers - 6 ECTS• Engineering Physics II (E&M;) - 6 ECTS• Electronics I (Circuits) - 6 ECTS• Engineering Ethics & Safety - 6 ECTS |
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Year 2

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| Semester 3 (30 ECTS) | <ul style="list-style-type: none">• Computer Organization & Assembly - 6 ECTS• Digital Systems II (FPGA/HDL) - 6 ECTS• Embedded Systems I - 6 ECTS• Signals & Systems (Intro) - 6 ECTS• Technical Elective I - 6 ECTS |
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| Semester 4 (30 ECTS) | <ul style="list-style-type: none">• Operating Systems - 6 ECTS• Microcontrollers & Interfaces - 6 ECTS• Electronics II (Analog & Mixed Signal) - 6 ECTS• Networks I - 6 ECTS• Technical Elective II - 6 ECTS |
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Year 3

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| Semester 5 (30 ECTS) | <ul style="list-style-type: none">• Computer Architecture - 6 ECTS• Real-Time Systems - 6 ECTS• Embedded Systems II (RTOS & Drivers) - 6 ECTS• Security Engineering Fundamentals - 6 ECTS• Technical Elective III - 6 ECTS |
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- Semester 6 (30 ECTS)**
- Hardware/Software Co-Design - 6 ECTS
 - Networks II (Wireless & IoT) - 6 ECTS
 - Control Systems (Intro) - 6 ECTS
 - Technical Elective IV - 6 ECTS
 - Industry Internship - 6 ECTS
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Year 4

Semester 7 (30 ECTS)	<ul style="list-style-type: none">• VLSI & SoC Design (Intro) - 6 ECTS• Edge AI & TinyML - 6 ECTS• Advanced Embedded Verification - 6 ECTS• Technical Elective V - 6 ECTS• Capstone Design I (Requirements & Prototype) - 6 ECTS
Semester 8 (30 ECTS)	<ul style="list-style-type: none">• Capstone Design II (Build & Test) - 12 ECTS• Reliable Systems Engineering - 6 ECTS• Engineering Entrepreneurship - 6 ECTS• Advanced Seminar & Presentation - 6 ECTS

Technical Elective Tracks

Choose at least 5 electives; focus on one track for specialization.

Track A — Embedded & IoT

- Low-Power Design
- Sensor Fusion
- Wireless Protocols
- IoT Cloud Integration

Track B — Digital Design & FPGA

- Advanced HDL Design
- Formal Verification
- High-Speed Interfaces
- Hardware Acceleration

Track C — Security & Systems

- Secure Boot & TPM
- Applied Cryptography

- Systems Hardening
- Penetration Testing Lab

Track D — Robotics & Edge AI

- Robotics Fundamentals
- Computer Vision at the Edge
- Control for Robotics
- Autonomous Systems

Laboratories & Facilities

Embedded Systems Lab

Benches with oscilloscopes, logic analyzers, debuggers, and sensor kits for rapid prototyping.

FPGA & Hardware Design Studio

Modern FPGA boards and EDA tool access for HDL development and verification.

Makerspace & PCB Prototyping

3D printers, laser cutters, and PCB milling/assembly resources for capstone builds.

Secure Systems Sandbox

Isolated environment for security labs, firmware analysis, and network experimentation.

Capstone Design Examples

- **Smart Home Energy Controller**
Design an IoT controller with secure onboarding, telemetry, and optimization logic.
- **FPGA Image Processing Pipeline**
Implement a real-time filter/feature pipeline accelerated on FPGA hardware.
- **Wearable Health Sensor Node**
Build a low-power wearable with signal conditioning and on-device inference.
- **Autonomous Line-Following Robot**
Integrate perception, control, and real-time constraints for robust autonomy.